	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	BRS	L1	19	wafer adj etch$3 adj bath	USPAT; EPO; JPO	2000/01/12 09:29			0
2	BRS	L2	23	wafer adj etch$3 adj bath	USPAT; EPO; JPO	2000/01/12 09:44			0
3	BRS	L3	0	etach$3 adj fluid	USPAT; EPO; JPO	2000/01/12 09:45			0
4	BRS	L4	420	etch$3 adj fluid	USPAT; EPO; JPO	2000/01/12 09:46			0
5	BRS	L5	1628	etch$3 adj bath	USPAT; EPO; JPO	2000/01/12 09:47			0
6	BRS	L6	160	5 and drain$3	USPAT; EPO; JPO	2000/01/12 09:47			0
7	BRS	L7	58	6 and wafer	USPAT; EPO; JPO	2000/01/12 09:47			0
8	BRS	L8	160	6 and bath	USPAT; EPO; JPO	2000/01/12 09:48			0
9	BRS	L10	30	6 and valve	USPAT; EPO; JPO	2000/01/12 09:48			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
10	BRS	L11	95	6 and drain$3 and top	USPAT; EPO; JPO	2000/01/12 09:50			0
11	BRS	L12	24	11 and 10	USPAT; EPO; JPO	2000/01/12 09:50			0
12	BRS	L15	3	13 and hf	USPAT; EPO; JPO	2000/01/12 09:50			0
13	BRS	L16	10	12 and 7	USPAT; EPO; JPO	2000/01/12 09:57			0
14	BRS	L17	7	8 and 9	USPAT; EPO; JPO	2000/01/12 10:03			0
15	BRS	L19	24	10 and 11	USPAT; EPO; JPO	2000/01/12 10:04			0
16	BRS	L20	6	9 and 8 and 24	USPAT; EPO; JPO	2000/01/12 10:35			0
17	BRS	L21	158	4 and clean$3	USPAT; EPO; JPO	2000/01/12 10:36			0
18	BRS	L22	52	21 and bath	USPAT; EPO; JPO	2000/01/12 10:36			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	ErrorDefinition	Errors
19	BRS	L23	29	22 and (hingley adj$10 rleas$3 adj$10 door)	USPAT; EPO; JPO	2000/01/12 10:38			0
20	BRS	L24	7	6 and door	USPAT; EPO; JPO	2000/01/12 10:45			0